

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	ASSIGNMENT		
CONVEYING PARTY DATA			
	Name	Execution Date	
	YUTA SAITO	10/26/2016	
	JUNJI TOMINAGA	10/26/2016	
	REIKO KONDO	10/26/2016	
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PROPERTY NUMBERS Total: 1			
	Property Type	Number	
	Application Number:	15349074	
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SIGNATURE:	/Marina F. Cunningham/		
DATE SIGNED:	12/02/2016		
Total Attachments: 2			
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ASSIGNMENT

THIS INSTRUMENT OF ASSIGNMENT WITNESSETH THAT:

WHEREAS, we, Yuta SAITO, Junji TOMINAGA and Reiko KONDO
residents of
c/o National Institute of Advanced Industrial Science and Technology of Tsukuba Central
5, 1-1, Higashi 1-chome, Tsukuba-shi, Ibaraki 305-8565, Japan
respectively, have invented improvements in

CRYSTAL ORIENTATION LAYER LAMINATED STRUCTURE,
ELECTRONIC MEMORY
AND
METHOD FOR MANUFACTURING CRYSTAL ORIENTATION LAYER
LAMINATED STRUCTURE

for which we have executed on even date herewith an application for Letters Patent of the
United States, and

WHEREAS, NATIONAL INSTITUTE OF ADVANCED INDUSTRIAL
SCIENCE AND TECHNOLOGY
a corporation of the Japan
having a place of business at 3-1, Kasumigaseki 1-chome, Chiyoda-ku, Tokyo 100-8921,
Japan
is desirous of acquiring an interest in said invention, said application and the Letters Patent
to be issued therefor;

NOW, THEREFORE, to all whom it may concern, be it known that for and
in consideration of the sum of ONE DOLLAR to each in hand paid and other good and
valuable consideration, the receipt whereof is hereby acknowledged, we have sold,
assigned and set over, and do hereby sell, assign and set over to said corporation, its
successors or assigns, the entire right, title and interest to and in said invention in the
United States and in all foreign countries, said United States application for Letters Patent
therefor and the Letters Patent when issued; and we do hereby authorize and request the

Commissioner of Patent and Trademarks to issue the Letters Patent based upon said application to said corporation as the assignees of our entire right, title and interest to and in the same, for the sole use and behoof of said corporation, its successors or assigns.

And we also hereby covenant and agree to sign all proper papers including divisional and other applications for patents and assignments thereof in the United States and application for patents and assignments in all foreign countries, and to execute all rightful oaths and to take any other proper action that may in the judgment of the said corporation be necessary for securing thereto full rights to said invention, all of the foregoing to be at the expense of said corporation.

IN TESTIMONY WHEREOF, we have hereunto set our hands and affixed our seals.

October 26, 2016

Date

By Yuta Saito
Yuta SAITO

October 26, 2016

Date

By Junji Tominaga
Junji TOMINAGA

October 26, 2016

Date

By Reiko Kondo
Reiko KONDO